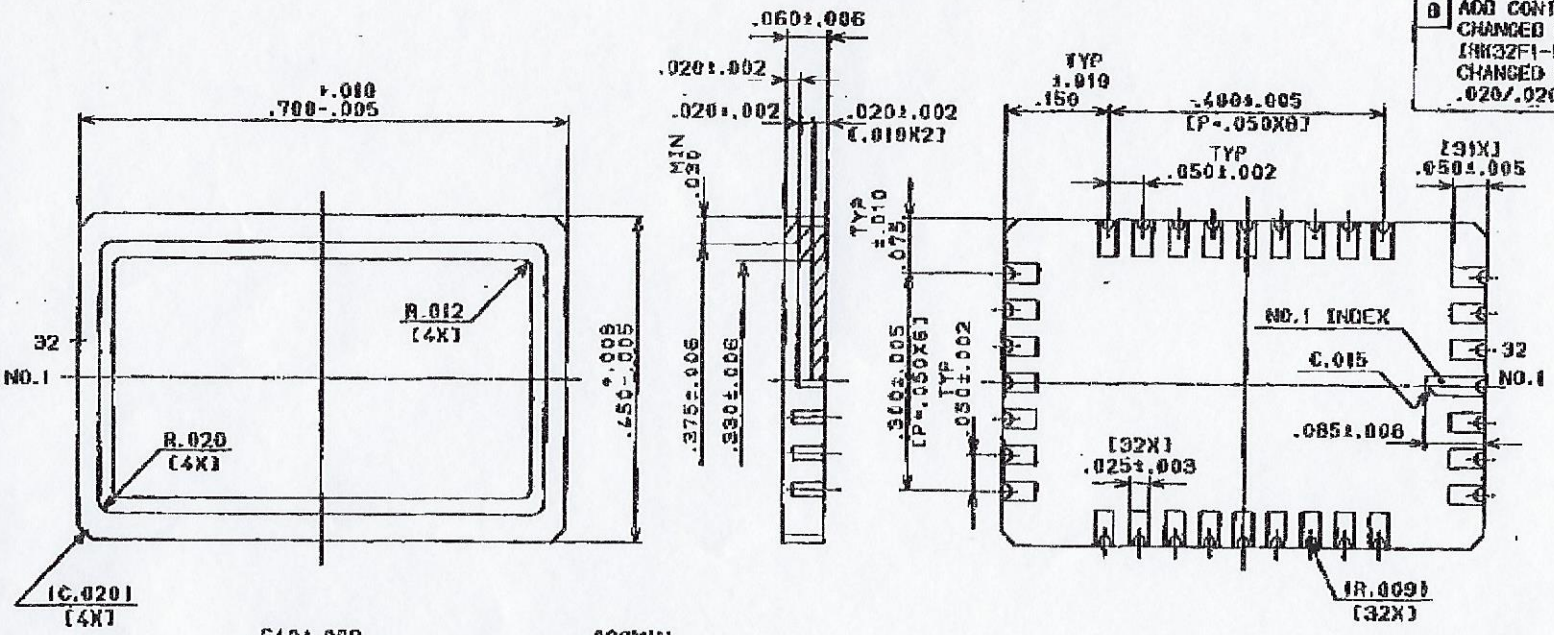
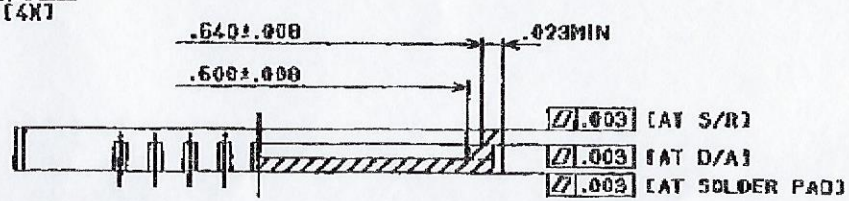
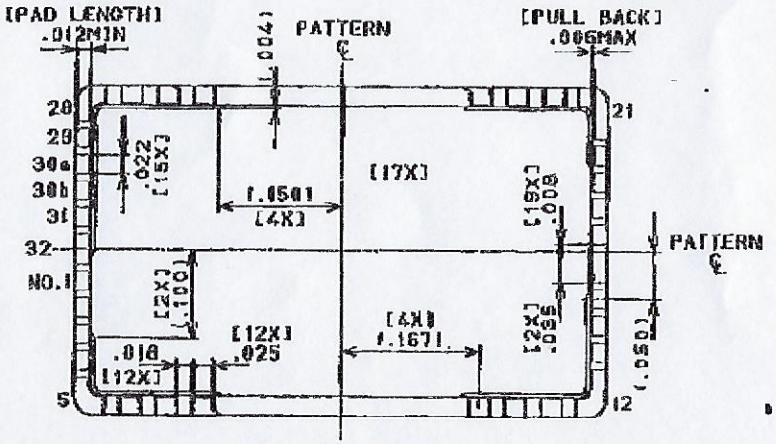
NTK

LATEST REVISION'S	DESCRIPTION
B	ADD CONTACT PAD NO.1 CHAMFER. CHANGED NTK DWG NO. [RK32F1-5344B WAS JRK32F1-5344A CHANGED CERAMIC TRK .020/.020/.020 WAS .015/.015/.030







B/G PADS DETAIL

NOTES:
1. GOLD PLATE 60μ INCHES MIN OVER 100μ INCHES MIN NICKEL.
2. NO LEAD TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD. SEAL RING ISOLATED.
3. PAD NO.30a TO BE CONNECTED TO NO.30 CONTACT PAD. PAD NO.30b TO BE CONNECTED TO NO.32 CONTACT PAD.

B	RE DRAWING	MAY-09-1990
A	RE DRAWING	DEC-11-1989
0	NEW DRAWING	NOV-14-1989
Rev.	Description	Date

3		
2		
1	CERAMIC	BLACK ALUMINA
Item	Name	Material

UNLESS OTHERWISE SPECIFIED TOLERANCE: ± 2°, M.L.T. W ±.XXX, .XX ±.01, .X ±.025, X ±.005

DRAWN K.HANAE
CHECKED
APPROVED
UNIT INCH
SCALE 1/1

CUSTOMER
DWG NO.

NTK TECHNICAL CERAMICS
NGK SPARK PLUG CO., LTD.

TITLE 32 LEAD CHIP CARRIER

DWG NO. JRK32F1-5344B

MODIFIED DWG NO.

PART NO. SHEET 1 OF 1 M·H